

October 1993 Revised April 2005

74LVX374

Low Voltage Octal D-Type Flip-Flop with 3-STATE Outputs

General Description

The LVX374 is a high-speed, low-power octal D-type flipflop featuring separate D-type inputs for each flip-flop and 3-STATE outputs for bus-oriented applications. A buffered Clock (CP) and Output Enable $(\overline{\text{OE}})$ are common to all flipflops. The inputs tolerate up to 7V allowing interface of 5V systems to 3V systems.

Features

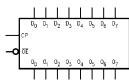
- Input voltage translation from 5V to 3V
- Ideal for low power/low noise 3.3V applications
- Guaranteed simultaneous switching noise level and dynamic threshold performance

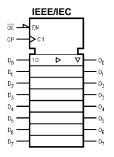
Ordering Code:

Order Number	Package Number	Package Description
74LVX374M	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LVX374SJ	M20D	Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVX374MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

Logic Symbols





Connection Diagram



Pin Descriptions

Pin Names Description						
D ₀ -D ₇	Data Inputs					
CP	Clock Pulse Input					
OE	3-STATE Output Enable Input					
O ₀ -O ₇	3-STATE Outputs					

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Truth Table

	Outputs				
D _n	СР	ŌĒ	O _n		
Н	~	L	Н		
L	~	L	L		
X	Х	Н	Z		

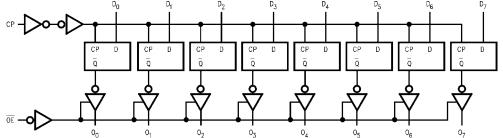
- H = HIGH Voltage Level L = LOW Voltage Level

Functional Description

The LVX374 consists of eight edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The buffered clock and buffered Output Enable are common to all flip-flops. The eight flip-flops will store the state of their individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition.

With the Output Enable (OE) LOW, the contents of the eight flip-flops are available at the outputs. When the OE is HIGH, the outputs go to the high impedance state. Operation of the OE input does not affect the state of the flip-

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC}) -0.5V to +7.0V

DC Input Diode Current (I_{IK})

 $\begin{array}{lll} \mbox{V}_{\mbox{\scriptsize I}} = -0.5 \mbox{\scriptsize V} & -20 \mbox{ mA} \\ \mbox{\scriptsize DC Input Voltage (V}_{\mbox{\scriptsize I}}) & -0.5 \mbox{\scriptsize V} \mbox{\scriptsize to 7V} \end{array}$

DC Output Diode Current (I_{OK})

$$\begin{split} \text{V}_{\text{O}} &= -0.5 \text{V} & -20 \text{ mA} \\ \text{V}_{\text{O}} &= \text{V}_{\text{CC}} + 0.5 \text{V} & +20 \text{ mA} \end{split}$$

DC Output Voltage (V_O) -0.5V to $V_{CC} + 0.5V$

DC Output Source

or Sink Current (I_O) $\pm 25 \text{ mA}$

DC V_{CC} or Ground Current

 $\begin{array}{ll} (I_{CC} \ or \ I_{GND}) & \pm 75 \ mA \\ \\ \mbox{Storage Temperature} \ (T_{STG}) & -65 \ ^{\circ}\mbox{C} \ to +150 \ ^{\circ}\mbox{C} \end{array}$

Power Dissipation 180mW

Recommended Operating Conditions (Note 2)

Input Rise and Fall Time ($\Delta t/\Delta V$) 0 ns/V to 100 ns/V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C			T _A = -40°	C to +85°C	Units	Conditions		
Cymbol	i arameter		Min	Тур	Max	Min	Max	Onits		munions	
V_{IH}	HIGH Level	2.0	1.5			1.5					
	Input Voltage	3.0	2.0			2.0		V			
		3.6	2.4			2.4					
V _{IL}	LOW Level	2.0			0.5		0.5				
	Input Voltage	3.0			0.8		0.8	V			
		3.6			0.8		0.8				
V _{OH}	HIGH Level	2.0	1.9	2.0		1.9			$V_{IN} = V_{IH}$	$I_{OH} = -50 \mu A$	
	Output Voltage	3.0	2.9	3.0		2.9		V	or V _{IL}	$I_{OH} = -50 \mu A$	
		3.0	2.58			2.48				$I_{OH} = -4mA$	
V _{OL}	LOW Level	2.0		0.0	0.1		0.1		$V_{IN} = V_{IH}$	$I_{OL} = 50 \mu A$	
	Output Voltage	3.0		0.0	0.1		0.1	V	or V _{IL}	$I_{OL}=50\mu A$	
		3.0			0.36		0.44			$I_{OL} = 4mA$	
I _{OZ}	3-STATE Output	3.6			±0.25		±2.5		$V_{IN} = V_{IH}$ or V_{IL}		
	Off-State Current							μΑ	V _{OUT} = V _{CC} or GND		
I _{IN}	Input Leakage Current	3.6			±0.1		±1.0	μА	V _{IN} = 5.5V or GND		
I _{CC}	Quiescent Supply Current	3.6			4.0		40.0	μA	V _{IN} = V _{CC} or GND		

Noise Characteristics (Note 3)

Symbol	Parameter	V _{CC}	T _A = 25°C		Units	C _L (pF)	
			Тур	Limit	• • • • • • • • • • • • • • • • • • • •		
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}		0.5	0.8	V	50	
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}		-0.5	-0.8	V	50	
V _{IHD}	Minimum HIGH Level Dynamic Input Voltage	3.3		2.0	V	50	
V _{ILD}	Maximum LOW Level Dynamic Input Voltage	3.3		0.8	V	50	

Note 3: Input $t_r = t_f = 3 \text{ ns}$

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AC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = +25°C			$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units	Conditions	
Symbol		(V)	Min	Тур	Max	Min	Max	Units	Conditions	
f _{MAX}	Maximum Clock	2.7	60	115		50			C _L = 15 pF	
	Frequency	•	45	60		40		MHz	C _L = 50 pF	
		3.3 ± 0.3	100	160		85		IVITIZ	C _L = 15 pF	
			60	95		55			C _L = 50 pF	
t _{PLH}	Propagation Delay Time	2.7		8.5	16.3	1.0	19.5		C _L = 15 pF	
t _{PHL}	CP to O _n	•		11.0	19.8	1.0	23.0	ns	C _L = 50 pF	
		3.3 ± 0.3		6.7	10.6	1.0	12.5	115	C _L = 15 pF	
				9.2	14.1	1.0	16.0		C _L = 50 pF	
t _{PZL}	3-STATE Output	2.7		7.6	14.5	1.0	17.5		$C_L = 15 \text{ pF}, R_L = 1 \text{ k}\Omega$	
t _{PZH}	Enable Time			10.1	18.0	1.0	21.0	ns	$C_L = 50 \text{ pF}, R_L = 1 \text{ k}\Omega$	
		3.3 ± 0.3		5.9	9.3	1.0	11.0	115	$C_L = 15 \text{ pF}, R_L = 1 \text{ k}\Omega$	
				8.4	12.8	1.0	14.5		$C_L = 50 \text{ pF}, R_L = 1 \text{ k}\Omega$	
t _{PLZ}	3-STATE Output	2.7		11.5	18.5	1.0	22.0	ns	$C_L = 50 \text{ pF}, R_L = 1 \text{ k}\Omega$	
t_{PHZ}	Disable Time	3.3 ± 0.3		9.6	13.2	1.0	15.0	115	$C_L = 50 \text{ pF}, R_L = 1 \text{ k}\Omega$	
t _W	CP Pulse	2.7	7.5			8.0		ns		
	Width	3.3 ± 0.3	5.0			5.5		113		
t _S	Setup Time	2.7	6.5			6.5		ns		
	D _n to CP	3.3 ± 0.3	4.5			4.5		113		
t _H	Hold Time	2.7	2.0			2.0		ns		
	D _n to CP	3.3 ± 0.3	2.0			2.0		115		
t _{OSLH}	Output to Output	2.7			1.5		1.5	ns	C _L = 50 pF	
toshl	Skew (Note 4)	3.3			1.5		1.5	115		

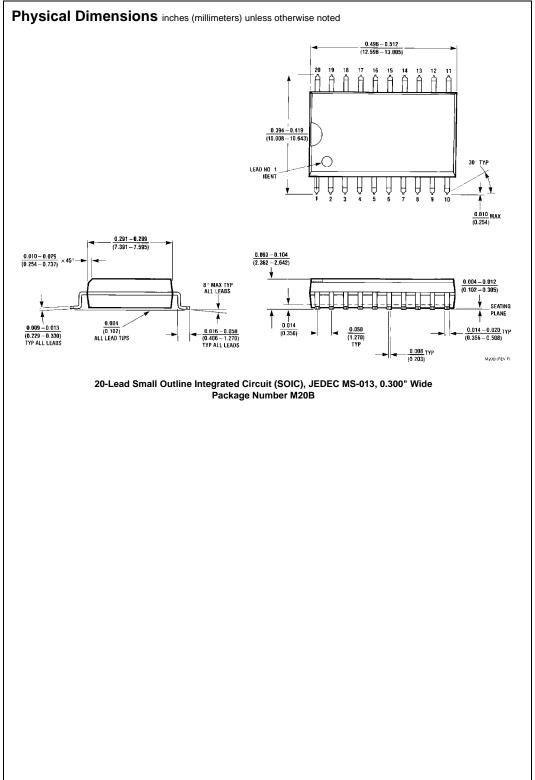
Note 4: Parameter guaranteed by design. $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$

Capacitance

Symbol	Parameter		T _A = +25°C		T _A = -40°C	Units	
	T arameter		Тур	Max	Min		Max
C _{IN}	Input Capacitance		4	10		10	pF
C _{OUT}	Output Capacitance		6				pF
C _{PD}	Power Dissipation		32				pF
	Capacitance (Note 5)						

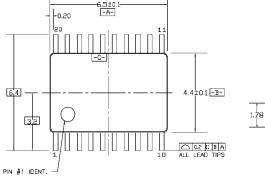
Note 5: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

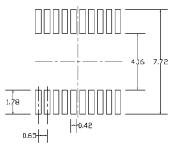
Average operating current can be obtained by the equation: $I_{CC(opr.)} = \frac{C_{PD} \times V_{CC} \times f_{|N} + I_{CC}}{8 \text{ (per F/F)}}$



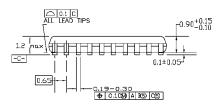
Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.6±0.10 0.40 TYP --A-5.01 TYP 5.3±0.10 9.27 TYP 7.8 -B-3.9 ○ 0.2 C B A ALL LEAD TIPS 10 PIN #1 IDENT.-0.6 TYP 1.27 TYP -LAND PATTERN RECOMMENDATION ALL LEAD TIPS SEE DETAIL A 0.1 C 2.1 MAX. 1.8±0.1 0.15±0.05 0.15-0.25 -1.27 TYP 0.35-0.51 **♦** 0.12 **⋈** C A DIMENSIONS ARE IN MILLIMETERS GAGE PLANE NOTES: 0.25 A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. 0.60±0.15-SEATING PLANE 1.25 -M20DRevB1 DETAIL A Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





LAND PATTERN RECOMMENDATION





DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MD-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M. 1982.

RO.09min GAGE PLANE SEATING PLANE RO.09min DETAIL A

MTC20REVD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

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